MOSFET – Power, Single P-Channel, Trench, SOT-23 -20 V

Features

- Leading -20 V Trench for Low R_{DS(on)}
- -1.8 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- NTRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Management for Portables
- Load/Power Management for Computing
- Charging Circuits and Battery Protection

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parame	Symbol	Value	Unit			
Drain-to-Source Voltage	V _{DSS}	-20	V			
Gate-to-Source Voltage	V _{GS}	±8.0	V			
Continuous Drain	Steady	$T_A = 25^{\circ}C$	I _D	-2.4	А	
Current (Note 1)	State	T _A = 85°C		-1.7		
	t ≤ 10 s	T _A = 25°C		-3.2		
Power Dissipation (Note 1)	$\begin{array}{c} \text{Steady} \\ \text{State} \end{array} \begin{array}{c} \text{T}_{\text{A}} = 25^{\circ}\text{C} \\ \end{array}$		PD	0.73	W	
	t ≤ 10 s			1.25	1	
Continuous Drain	Steady	T _A = 25°C	I _D	-1.8	А	
Current (Note 2)	State	T _A = 85°C		-1.3		
Power Dissipation (Note 2)		$T_A = 25^{\circ}C$	PD	0.42	W	
Pulsed Drain Current	tp =	=10 μs	I _{DM}	-18	А	
ESD Capability (Note 3)	bability (Note 3) C = 100 pF, RS = 1500 Ω				V	
Operating Junction and S	T _J , T _{STG}	–55 to 150	°C			
Source Current (Body Dio	۱ _S	-2.4	Α			
Single Pulse Drain-to-So Energy (V _{GS} = -8 V, I _L = - R_G = 25 Ω)	EAS	16	mJ			
Lead Temperature for Sole Purposes (1/8" from case	ΤL	260	°C			

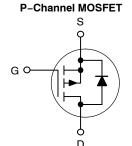
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



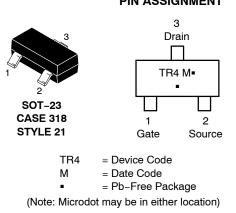
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V _{(BR)DSS}	R _{DS(ON)} TYP	I _D MAX	
	70 mΩ @ –4.5 V		
–20 V	90 mΩ @ –2.5 V	–3.2 A	
	112 mΩ @ –1.8 V		



MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]		
NTR4101PT1G	SOT-23	3000 / Tape &		
NTRV4101PT1G	(Pb-Free)	Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter		Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	170	°C/W
Junction-to-Ambient - t < 10 s (Note 1)	$R_{\theta JA}$	100	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	300	

Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
Surface-mounted on FR4 board using the minimum recommended pad size.

3. ESD Rating Information: HBM Class 0

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

CI	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Volta (V _{GS} = 0 V, I _D = -250 μ A)	V _{(BR)DSS}	-20			V	
Zero Gate Voltage Drain Current ($(V_{GS} = 0 V, V_{DS} = -16 V)$	Note 4)	I _{DSS}			-1.0	μΑ
Gate-to-Source Leakage Current ($V_{GS} = \pm 8.0 \text{ V}$, $V_{DS} = 0 \text{ V}$)		I _{GSS}			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage (Note 4) $(V_{GS} = V_{DS}, I_D = -250 \ \mu\text{A})$		V _{GS(th)}	-0.4	-0.72	-1.2	V
$\begin{array}{l} Drain-to-Source \ On-Resistance \\ (V_{GS}=-4.5 \ V, \ I_D=-1.6 \ A) \\ (V_{GS}=-2.5 \ V, \ I_D=-1.3 \ A) \\ (V_{GS}=-1.8 \ V, \ I_D=-0.9 \ A) \end{array}$	R _{DS(on)}		70 90 112	85 120 210	mΩ	
Forward Transconductance (V _{DS} =	g fs		7.5		S	
CHARGES, CAPACITANCES & GA	TE RESISTANCE					
Input Capacitance		C _{iss}		675		pF
Output Capacitance	(V _{GS} = 0 V, f = 1 MHz, V _{DS} = –10 V)	C _{oss}		100		
Reverse Transfer Capacitance		C _{rss}		75		
Total Gate Charge	$(V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_D = -1.6 \text{ A})$	Q _{G(tot)}		7.5	8.5	nC
Gate-to-Source Gate Charge	(V _{DS} = -10 V, I _D = -1.6 A)	Q _{GS}		1.2		nC
Gate-to-Drain "Miller" Charge	(V _{DS} = -10 V, I _D = -1.6 A)	Q _{GD}		2.2		nC
Gate Resistance		R _G		6.5		Ω
WITCHING CHARACTERISTICS	(Note 5)	1			I	
Turn-On Delay Time		t _{d(on)}		7.5		ns
Rise Time	(V _{GS} = -4.5 V, V _{DS} = -10 V,	t _r		12.6		
Turn-Off Delay Time	$I_{\rm D} = -1.6 \text{ A}, \text{ R}_{\rm G} = 6.0 \Omega)$	t _{d(off)}		30.2		
Fall Time	1	t _f		21.0		
DRAIN-SOURCE DIODE CHARAC	TERISTICS			-	•	
Forward Diode Voltage	$(V_{GS} = 0 V, I_S = -2.4 A)$	V _{SD}		-0.82	-1.2	V
Reverse Recovery Time		t _{rr}		12.8	15	ns
$\label{eq:chargeTime} \begin{array}{c} (V_{GS}=0V,\\ dI_{SD}/dt=100A/\mu s,I_{S}=-1.6A) \end{array}$ Discharge Time		t _a		9.9		ns
		t _b		3.0		ns
Reverse Recovery Charge	Q _{rr}		1008		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

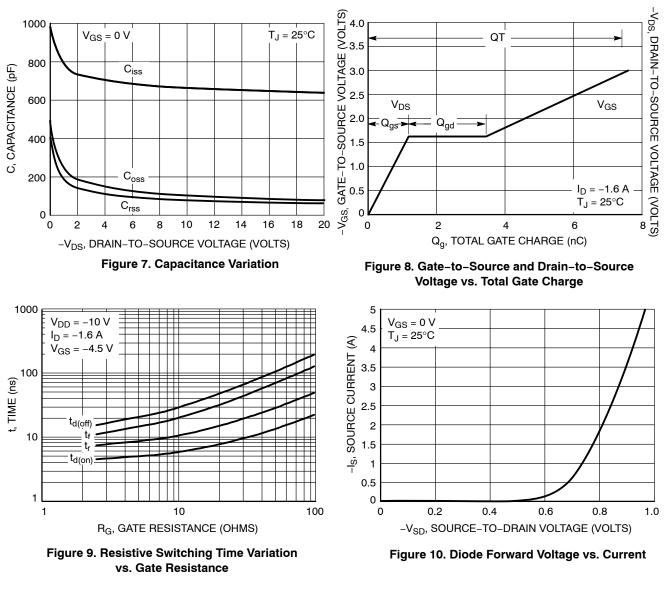
4. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.

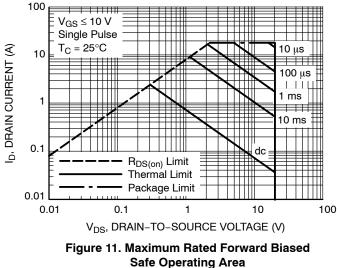
5. Switching characteristics are independent of operating junction temperature.

10 10 $T_J = 25^{\circ}C$ $T_J = -55^{\circ}C$ V_{GS} = -10 V - -2.4 V 9 -I_{D.} DRAIN CURRENT (AMPS) ID, DRAIN CURRENT (AMPS) 25°C –2.2 V 8 8 125°C 7 -2.0 V 6 6 5 –1.8 V 4 4 3 –1.6 V 2 2 1 $V_{DS} \ge 20 V$ 0 0 2 3 5 6 7 8 0 4 0 2 3 4 6 1 1 5 -V_{GS}, GATE-TO-SOURCE VOLTAGE (VOLTS) -V_{DS}, DRAIN-TO-SOURCE VOLTAGE (VOLTS) Figure 1. On–Region Characteristics Figure 2. Transfer Characteristics R_{DS(on)}, DRAIN-TO-SOURCE RESISTANCE (Q) 0.1 V_{GS} = -5.0 V $T_J = 25^{\circ}C$ T = 125°C 0.09 0.08 V_{GS} = -2.5 V T = 25°C 0.07 0.06 T = -55°C 0.05 V_{GS} = -4.5 V 0.04 0.03 0.02 0.01 R_{DS(on)}, I 0.01 0 0 7 9 4 1 3 5 1 2 3 5 6 7 8 9 10 -ID, DRAIN CURRENT (AMPS) -ID. DRAIN CURRENT (AMPS) Figure 4. On-Resistance vs. Drain Current and Figure 3. On-Resistance vs. Drain Current and Temperature Temperature 100000 $V_{GS} = 0 V$ $I_{D} = -1.6 \text{ A}$ -100001 -1_{DSS}, LEAKAGE (nA) 1.4 R_{DS(on)}, DRAIN-TO-SOURCE RESISTANCE (NORMALIZED) $T_J = 150^{\circ}C$ 1.2 1.0 T_J = 125°C 0.8 10 0.6 0.4 1.0 -25 25 50 75 100 125 2 6 8 -50 0 150 0 4 10 12 14 16 T_J, JUNCTION TEMPERATURE (°C) -V_{DS.} DRAIN-TO-SOURCE VOLTAGE (VOLTS) Figure 5. On-Resistance Variation with Figure 6. Drain-to-Source Leakage Current Temperature vs. Voltage

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

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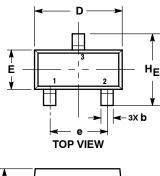


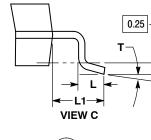


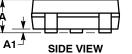
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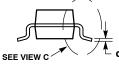
PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AR









END VIEW

NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF

THE BASE MATERIAL. 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

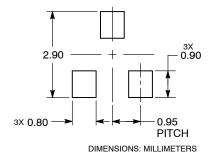
PROTE	RUSIONS,	OR GATE	BURRS.			-
MILLIMETERS				INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MA)
Δ	0.80	1.00	1 11	0.035	0.030	0.04

				INCILO		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	0°		10°	0°		10°

STYLE 12: PIN 1. CATHODE 2. CATHODE

3. ANODE

RECOMMENDED SOLDERING FOOTPRINT



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